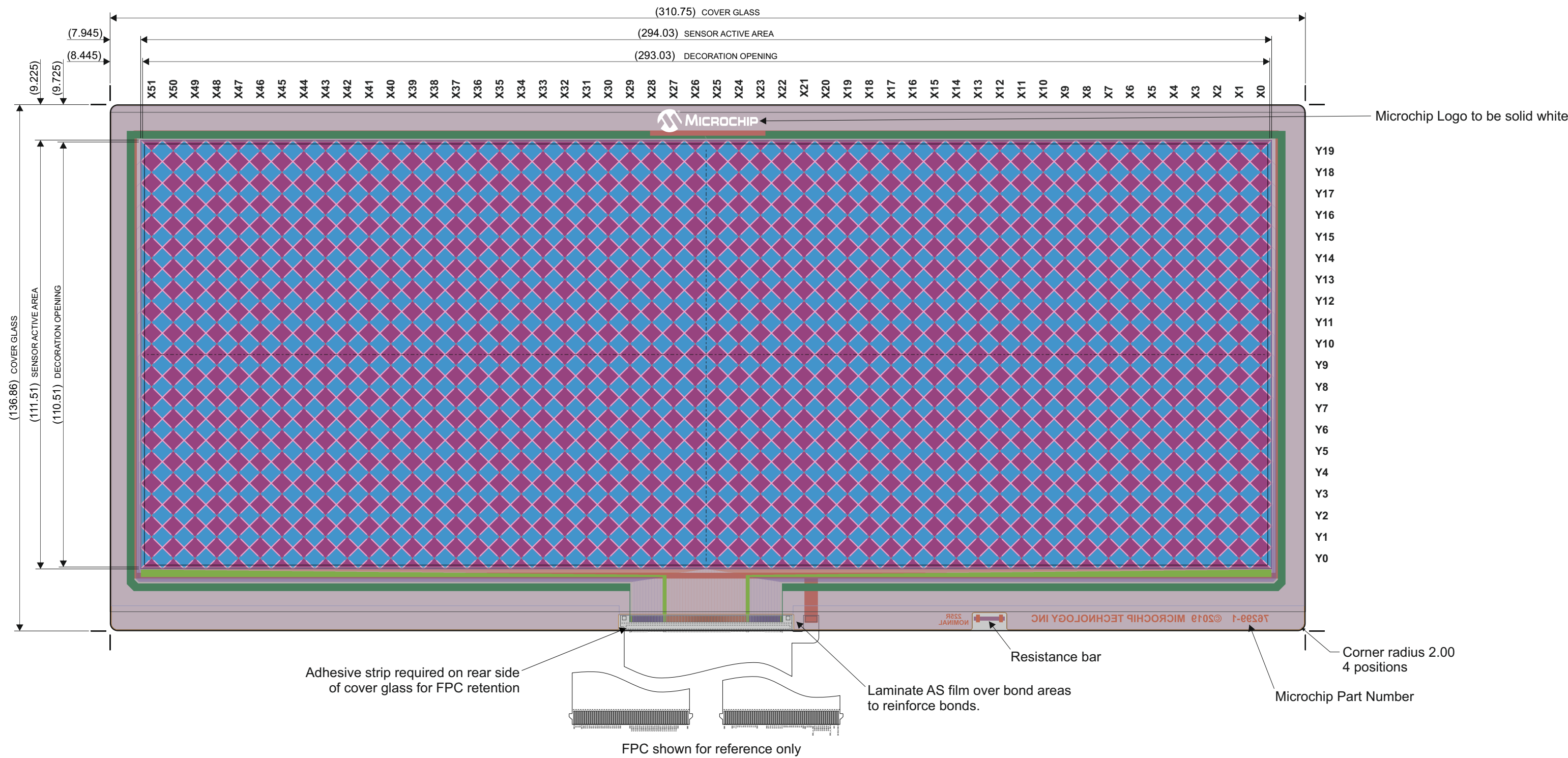


STRICTLY CONFIDENTIAL

SUBJECT TO NON-DISCLOSURE AGREEMENT
THIS DRAWING IS FOR SAMPLES & PROTOTYPES ONLY
TO BE ISSUED TO MICROCHIP APPROVED MANUFACTURERS ONLY



Artwork drawn as viewed from Touch Side

Edges of cover glass to be polished with no sharp corners

All dimensions are in millimeters.
If In Doubt Please Ask.

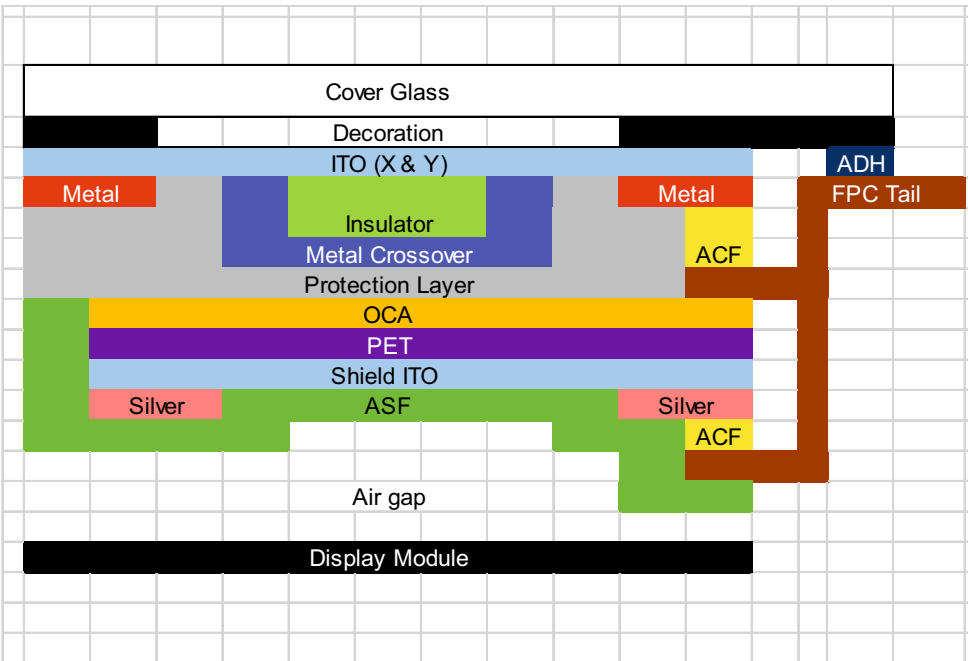
Layers (top to bottom)

Cover glass
ITO Pattern 55 ohm/sq
Insulator
Metal crossovers 0.4 ohm/sq
Metal tracks 0.4 ohm/sq
Protection layer
OCA
PET Film
ITO Shield 75 ohm/sq
Silver track 0.15 ohm/sq
Anti-splinter film

Crossover Detail

insulator thickness = 1.25um
under track width = 70um
ITO resistance = 55±10 Ohm/sq
crossover track width = 12um
crossover metal track resistance = 0.4 Ohm/sq
crossover track resistive length = 200 um

Touchscreen Build Stack



Material	Thickness (mm)
Dragontrail glass	1.10
Decoration print	0.02
ITO 55±10 Ohm/sq	-
Metal tracking 0.4 Ohm/sq	-
Insulator	-
Metal Crossover 0.4 Ohm/sq	-
Insulator	0.003
OCA	0.25
PET film	0.125
ITO 75±15 Ohm/sq	-
Silver tracking 0.15 Ohm/sq	-
Anti-splinter film	0.079
Touchscreen Thickness	1.577
Air	0.3
Display module	-
Hot Bar Bond Heatseal / ACF	0.005
FPC Tail	0.09

Preliminary Drawing
Not for Manufacture

All components and materials used must be RoHS compliant as described in European Parliament Directive 2002/95/EC

1	First Issue	N/A	PFC	10th Oct 2019
Iss	Notes	ECN	Drm	Date

Title: 12.3" ITO on Glass TS Single Diamond G2 52X 20Y	Project: mXT1296M1T
Number: 76299	CAD Check: Engr Check:
Filename: 76299.cdr	Approved:
Sheet 1 of 2	Drawn: P Cassidy

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Material Specifications

	Material	Thickness	Specification	design rules
Main ITO	ITO	0.03um	55 Ohms/sq ± 10 Ohms	Minimum track / gap = 30um ± 10%
Insulator	Insulator	1.25um ± 0.25um	Er = 3.60	
Metal crossovers	Metal	0.3um	0.4 Ohms/sq ± 10%	Minimum track width 12um
Metal tracks	Metal	0.3um	0.4 Ohms/sq ± 10%	Minimum track / gap = 30um ± 10%
Protection Layer	Insulator	3um ± 0.25um	Er = 3.60	
OCA	Optically clear adhesive	0.25mm ± 10%	Er = 4.60	
PET	PET film	0.125mm ± 10%	Er = 3.00	
Shield ITO	ITO	0.03um	75 Ohms/sq ± 15 Ohms	
Silver tracks	Silver	8um ± 10%	0.15 Ohms/sq ± 10%	Minimum track width 500um
Anti-splinter film	PET/OCA	0.079mm ± 10%	Er = 3.00	
FPC interconnect	ACF / ACP / ACA	<20um	Pad contact resistance <1 Ohm, Peel strength >5N/cm	Pads 0.20 x 1.8mm on 0.4mm pitch
Alignment Tolerances				
Layer to Layer Alignment		± 15um		
Print to Edge of Glass		± 200um		
Metal to ITO		± 15um		
Assumptions				
Cover Glass	Dragontrail Glass or similar	1.10mm ± 10%	Er = 7.37	
Decoration	Black Pantone EC non-conductive ink Logo white non-conductive ink	20um ± 5um	Er = 3	
Airgap to display	Air	0.30mm ± 10%	Er = 1.01	
Performance Calculations				
Charge Time		2.93us		
Worst case touch separation in X		11.87mm		
Worst case touch separation in Y		11.71mm		
Touch separation difference		0.17mm		

Preliminary Drawing
Not for Manufacture

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